

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Handwritten:
J. Jones
#16
11/22/02

Applicant: Sun, et al
Serial No.: 09/875,597
Filed: 06/06/2001
Group Art Unit: 2834
Examiner: Teresinski, John
Title: Structural Integrity Monitoring System Including Wireless
Electromechanical Impedance Measurement

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner of Patents
Washington, D.C. 20231

Dear Sir:

Pursuant to Applicant's duty of candor and in accordance with 37 CFR 1.97(c)(2), Applicant submits the enclosed PTO 1449 and copies of the references listed on that document. The fee of \$180.00 pursuant to 37 CFR 1.17(p) is paid by the enclosed check. The Commissioner is hereby authorized to charge Deposit Account No. 50-1482 in the name of Carlson, Gaskey & Olds for any additional fees or credit the account for any overpayment.

Respectfully submitted,

CARLSON, GASKEY & OLDS

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Dated: November 11, 2002

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CERTIFICATE OF MAILING

I hereby certify that the enclosed Supplemental Information Disclosure Statement is being deposited with the United States Postal Service as First Class Mail, postage prepaid, in an envelope addressed to Assistant Commissioner of Patents, Washington D.C. 20231 on November 11, 2002.


Theresa M. Palmateer

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